

3M™ HDC Header

.100" Vertical Mount, PCB/Backplane, Solder Tail or Press-Fit

HDC Series



- High density, up to 240 contacts single bay
- Early Mate Late Break (EMLB) grounding contacts for hot swapping
- Mates with three-row and four-row sockets
- RoHS* compliant. See the Regulatory Information Appendix (RIA) in the "RoHS compliance" section of www.3Mconnector.com for compliance information (RIA E1 & C1 apply)

Date Modified: April 14, 2010

TS-1136-D
Sheet 1 of 5

Physical

Insulation:

Material: Glass Filled Thermoplastic (LCP)

Flammability: UL 94V-0

Color: Black

Contact:

Material: Copper Alloy

Plating:

Underplating: 50 μ " [1.27 μ m] min. Nickel

Wiping Area: See Ordering Information

Termination Area: See Ordering Information

Marking: Part Number and Date Code

Electrical

Current Rating: 3.0 A

Insulation Resistance: 1×10^3 M Ω min. at 500 V_{DC}

Withstanding Voltage: 900 V_{AC} for 1 minute

Environmental

Temperature Rating: -55°C to +105°C

Process Rating: Maximum 260°C (per J-STD-020C)

Moisture Sensitivity Level: 1 (per J-STD-020C)

UL File No.: E68080

3M

Electronic Solutions Division
Interconnect Solutions
<http://www.3Mconnector.com>

3M is a trademark of 3M Company.
For technical, sales or ordering information call
800-225-5373

3M™ HDC Header

.100" Vertical Mount, PCB/Backplane, Solder Tail or Press-Fit

HDC Series

3-Row Single Bay



Inch
[mm]

Tolerance Unless Noted			
	.0	.00	.000
inch	±.1	±.01	±.005

[] Dimensions for Reference Only



TS-1136-D
Sheet 2 of 5

3M™ HDC Header

.100" Vertical Mount, PCB/Backplane, Solder Tail or Press-Fit

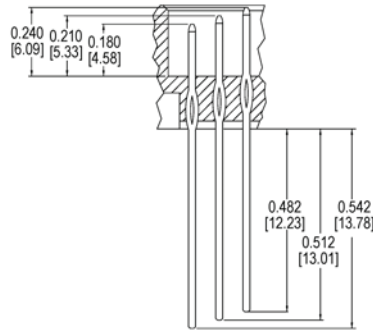
HDC Series

Product Table/Dimensions for 3 Row, Single Bay					
Description	Pin Quantity	A	B	C	D
HDC-H045-31XX-XXXX	45	2.250 [57.15]	1.950 [49.53]	1.400 [35.56]	1.550 [39.37]
HDC-H072-31XX-XXXX	72	3.150 [80.01]	2.850 [72.39]	2.300 [58.42]	2.300 [62.23]
HDC-H075-31XX-XXXX	75	3.250 [82.55]	2.950 [74.93]	2.400 [60.96]	2.550 [64.77]
HDC-H090-31XX-XXXX	90	3.750 [95.25]	3.450 [87.63]	2.900 [73.66]	3.050 [77.47]
HDC-H096-31XX-XXXX	96	3.950 [100.33]	3.650 [92.71]	3.100 [78.74]	3.250 [82.55]
HDC-H102-31XX-XXXX	102	4.150 [105.41]	3.850 [97.79]	3.300 [83.82]	3.450 [87.63]
HDC-H120-31XX-XXXX	120	4.750 [120.65]	4.450 [113.03]	3.900 [113.03]	4.050 [102.87]
HDC-H135-31XX-XXXX	135	5.250 [133.35]	4.950 [125.73]	4.400 [111.76]	4.550 [115.57]

Description	Pin Quantity	A	B	C	D
HDC-H150-31XX-XXXX	150	5.750 [146.05]	5.450 [138.43]	4.900 [124.46]	5.050 [128.27]
HDC-H165-31XX-XXXX	165	6.250 [158.75]	5.950 [151.13]	5.400 [137.16]	5.550 [140.97]
HDC-H180-31XX-XXXX	180	6.750 [171.45]	6.450 [163.83]	5.900 [149.86]	6.050 [153.67]
HDC-H195-31XX-XXXX	195	7.250 [184.15]	6.950 [176.53]	6.400 [162.56]	6.550 [166.37]
HDC-H210-31XX-XXXX	210	7.750 [196.85]	7.450 [189.23]	6.900 [175.26]	7.050 [179.07]
HDC-H225-31XX-XXXX	225	8.250 [209.55]	7.950 [201.93]	7.400 [187.96]	7.550 [191.77]
HDC-H228-31XX-XXXX	228	8.350 [212.09]	8.050 [204.47]	7.500 [190.50]	7.650 [194.31]
HDC-H240-31XX-XXXX	240	8.750 [222.25]	8.450 [214.63]	7.900 [200.66]	8.050 [204.47]



PCB HOLE SPECIFICATION FOR COMPLIANT PIN INSTALLATION



EXAMPLE "EMLB"



Plating Description

Ordering Information

HDC - HXXX - X1XX - XXXX

Pin Quantity:
See Table

Row Options
3 = 3 Rows
4 = 4 Rows

Insulator Options
1 = Single bay insulator

Termination Style / Lead length - Dim. F
 P1 - Press-fit / 0.200" (5.08)
 P2 - Press-fit / 0.533" (13.54)
 S1 - Solder Tail / 0.190" (4.83)

Plating Options:
(See Plating Chart)

Plating Chart (S1 & P1 Termination Styles ONLY)			
Plating Suffix	Press-Fit Terminations	Solder Tail Terminations	Plating composition
TG30	(RIA E2 & C2 apply)	(RIA E3 & C2 apply)	30 μ" [0.76 μm] Min. Au Area 1 100 μ" [2.54 μm] Min. Tin Lead Tail Area 4 50 μ" [1.27 μm] Min. Ni all over
KR	(RIA E1 & C1 apply)	(RIA E1 & C1 apply)	30 μ" [0.76 μm] Min. Au on Area 1 100 μ" [2.54 μm] Min. Whisker Mitigating Matte Tin on Area 4 50 μ" [1.27 μm] Min. Ni all over

Plating Chart (P2 Termination Styles ONLY)			
Plating Suffix	Press-Fit Terminations	Solder Tail Terminations	Plating composition
KV	(RIA E1 & C1 apply)	(RIA E1 & C1 apply)	30 μ" [0.76 μm] Min. Au on area 1 30 μ" [0.76 μm] Min. Au on area 2 3 μ" [0.08 μm] Min. Au on area 3 50 μ" [1.27 μm] Min. Ni all over

TS-1136-D
Sheet 3 of 5

3M™ HDC Header

.100" Vertical Mount, PCB/Backplane, Solder Tail or Press-Fit

HDC Series

4-Row Single Bay



RECOMMENDED P.C.B. HOLE PATTERN

TS-1136-D
Sheet 4 of 5

3M™ HDC Header

.100" Vertical Mount, PCB/Backplane, Solder Tail or Press-Fit

HDC Series

Product Table/Dimensions for 4-Row, Single Bay					
Description	Pin Quantity	A	B	C	D
HDC-H060-41XX-XXXX	60	2.250 [57.15]	1.950 [49.53]	1.400 [49.53]	1.550 [39.37]
HDC-H076-41XX-XXXX	76	2.650 [67.31]	2.350 [59.69]	1.800 [45.72]	1.950 [49.53]
HDC-H080-41XX-XXXX	80	2.750 [69.85]	2.450 [62.23]	1.900 [48.26]	1.900 [52.07]
HDC-H100-41XX-XXXX	100	3.250 [82.55]	2.950 [74.93]	2.400 [60.96]	2.550 [60.96]
HDC-H120-41XX-XXXX	120	3.750 [95.25]	3.450 [87.63]	2.900 [73.66]	3.050 [87.63]
HDC-H128-41XX-XXXX	128	3.950 [100.33]	3.650 [92.71]	3.100 [78.74]	3.250 [82.55]
HDC-H140-41XX-XXXX	140	4.250 [107.95]	3.950 [100.33]	3.400 [86.36]	3.550 [90.17]
HDC-H160-41XX-XXXX	160	4.750 [120.65]	4.450 [113.03]	3.900 [99.06]	4.050 [102.87]
HDC-H168-41XX-XXXX	168	4.950 [125.73]	4.650 [118.11]	4.100 [104.14]	4.250 [107.95]
HDC-H180-41XX-XXXX	180	5.250 [133.35]	4.950 [125.73]	4.400 [111.76]	4.550 [115.57]
HDC-H200-41XX-XXXX	200	5.750 [146.05]	5.450 [138.43]	4.900 [124.46]	5.050 [128.27]
HDC-H216-41XX-XXXX	216	6.150 [156.21]	5.850 [148.59]	5.300 [134.62]	5.450 [138.43]
HDC-H220-41XX-XXXX	220	6.250 [158.75]	5.950 [151.13]	5.400 [137.16]	5.550 [140.97]
HDC-H240-41XX-XXXX	240	6.750 [171.45]	6.450 [163.83]	5.900 [149.86]	6.050 [149.86]
HDC-H260-41XX-XXXX	260	7.250 [184.15]	6.950 [176.53]	6.400 [162.56]	6.550 [166.37]
HDC-H280-41XX-XXXX	280	7.750 [196.85]	7.450 [189.23]	6.900 [175.26]	7.050 [179.07]
HDC-H300-41XX-XXXX	300	8.250 [209.55]	7.950 [209.55]	7.400 [187.96]	7.550 [191.77]
HDC-H320-41XX-XXXX	320	8.750 [222.25]	8.450 [214.63]	7.900 [200.66]	8.050 [204.47]

TS-1136-D
Sheet 5 of 5

Important Notice

All statements, technical information, and recommendations related to 3M's products are based on information believed to be reliable, but the accuracy or completeness is not guaranteed. Before using this product, you must evaluate it and determine if it is suitable for your intended application. You assume all risks and liability associated with such use. Any statements related to the product which are not contained in 3M's current publications, or any contrary statements contained on your purchase order shall have no force or effect unless expressly agreed upon, in writing, by an authorized officer of 3M.

Warranty; Limited Remedy; Limited Liability.

This product will be free from defects in material and manufacture for a period of one (1) year from the time of purchase. **3M MAKES NO OTHER WARRANTIES INCLUDING, BUT NOT LIMITED TO, ANY IMPLIED WARRANTY OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE.** If this product is defective within the warranty period stated above, your exclusive remedy shall be, at 3M's option, to replace or repair the 3M product or refund the purchase price of the 3M product. **Except where prohibited by law, 3M will not be liable for any indirect, special, incidental or consequential loss or damage arising from this 3M product, regardless of the legal theory asserted.**

**3M Electronics Solutions Division**

6801 River Place Blvd.
Austin, TX 78726-9000
U.S.A.
1-800-225-5373
www.3Mconnector.com

Please recycle. Printed in USA.
© 3M 2010. All rights reserved.
RIA-2217B-E

3M is a trademark of 3M Company.

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9